

APFA3010LSEKJ3ZGKQBC

3.0 x 1.0 mm Right Angle SMD Chip LED Lamp



DESCRIPTIONS

- The Hyper Red device is based on light emitting diode chip made from AlGaNp
- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode
- The Blue source color devices are made with InGaN Light Emitting Diode
- Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

FEATURES

- 3.0 x 1.5 x 1.0 mm right angle SMD LED, 1.0 mm thickness
- Low power consumption
- Wide viewing angle
- Ideal for backlight and indicator
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- Tinned pads for improved solderability
- Halogen-free
- RoHS compliant

APPLICATIONS

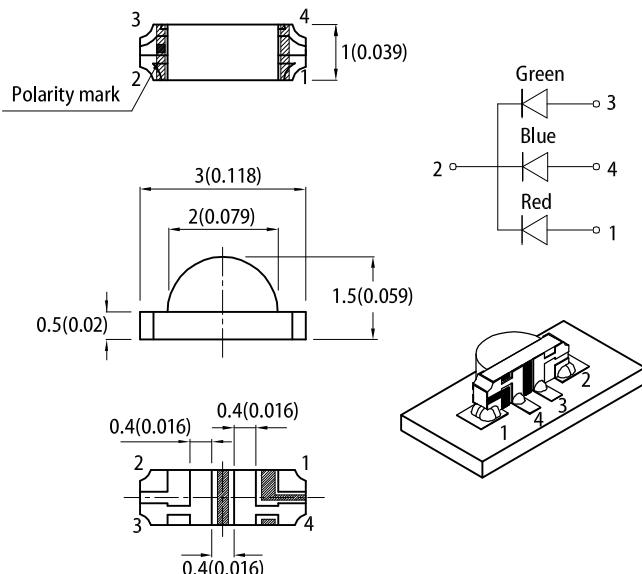
- Backlight
- Status indicator
- Home and smart appliances
- Wearable and portable devices
- Healthcare applications

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

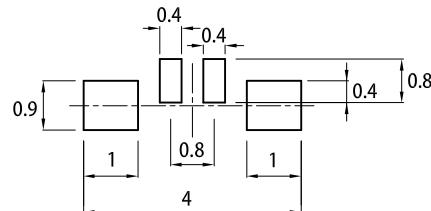


PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : ± 0.1)



Notes:

- All dimensions are in millimeters (inches).
- Tolerance is $\pm 0.2(0.008")$ unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
- The device has a single mounting surface. The device must be mounted according to the specifications.
- For right angle SMD LEDs, the solder stencil should be at least 5mil in thickness, to prevent poor solder wetting due to insufficient solder paste.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	I _v (mcd) @ 2mA ^[2]		Viewing Angle ^[1]
			Min.	Typ.	
APFA3010LSEKJ3ZGKQBC	Hyper Red (AlGaNp)	Water Clear	20	40	150°
	Green (InGaN)		50	90	
	Blue (InGaN)		4	10	

Notes:

- $\theta/2$ is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Luminous intensity / luminous flux: $\pm 15\%$.
- Luminous intensity value is traceable to CIE127-2007 standards.



ELECTRICAL / OPTICAL CHARACTERISTICS at $T_A=25^\circ\text{C}$

Parameter	Symbol	Emitting Color	Value		Unit
			Typ.	Max.	
Wavelength at Peak Emission $I_F = 2\text{mA}$	λ_{peak}	Hyper Red Green Blue	640 515 460	-	nm
Dominant Wavelength $I_F = 2\text{mA}$	$\lambda_{\text{dom}}^{[1]}$	Hyper Red Green Blue	625 525 465	-	nm
Spectral Bandwidth at 50% Φ REL MAX $I_F = 2\text{mA}$	$\Delta\lambda$	Hyper Red Green Blue	20 35 25	-	nm
Forward Voltage $I_F = 2\text{mA}$	$V_F^{[2]}$	Hyper Red Green Blue	1.8 2.65 2.65	2.1 3.1 3.1	V
Reverse Current ($V_R = 5\text{V}$)	I_R	Hyper Red Green Blue	-	10 50 50	μA
Temperature Coefficient of λ_{peak} $I_F = 2\text{mA}$, $-10^\circ\text{C} \leq T \leq 85^\circ\text{C}$	$TC_{\lambda_{\text{peak}}}$	Hyper Red Green Blue	0.13 0.05 0.04	-	$\text{nm}/^\circ\text{C}$
Temperature Coefficient of λ_{dom} $I_F = 2\text{mA}$, $-10^\circ\text{C} \leq T \leq 85^\circ\text{C}$	$TC_{\lambda_{\text{dom}}}$	Hyper Red Green Blue	0.06 0.03 0.03	-	$\text{nm}/^\circ\text{C}$
Temperature Coefficient of V_F $I_F = 2\text{mA}$, $-10^\circ\text{C} \leq T \leq 85^\circ\text{C}$	TC_V	Hyper Red Green Blue	-2.0 -3.0 -3.0	-	$\text{mV}/^\circ\text{C}$

Notes:

1. The dominant wavelength (λ_d) above is the setup value of the sorting machine. (Tolerance $\lambda_d: \pm 1\text{nm}$.)
2. Forward voltage: $\pm 0.1\text{V}$.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at $T_A=25^\circ\text{C}$

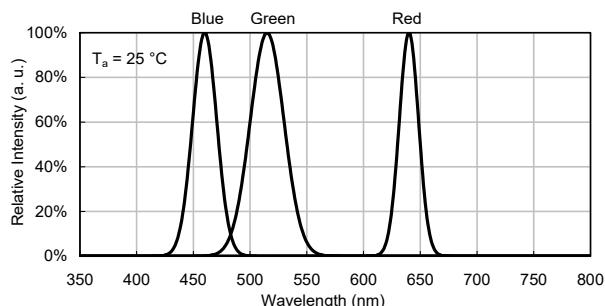
Parameter	Symbol	Value			Unit
		Hyper Red	Green	Blue	
Power Dissipation	P_D	84	102.5	120	mW
Reverse Voltage	V_R	5	5	5	V
Junction Temperature	T_j	115	115	115	$^\circ\text{C}$
Operating Temperature	T_{op}	-40 to $+85$			$^\circ\text{C}$
Storage Temperature	T_{stg}	-40 to $+85$			$^\circ\text{C}$
DC Forward Current	I_F	30	25	30	mA
Peak Forward Current	$I_{\text{FP}}^{[1]}$	150	150	150	mA
Electrostatic Discharge Threshold (HBM)	-	3000	450	250	V
Thermal Resistance (Junction / Ambient)	$R_{\text{th JA}}^{[2]}$	360	570	630	$^\circ\text{C}/\text{W}$
Thermal Resistance (Junction / Solder point)	$R_{\text{th JS}}^{[2]}$	260	460	520	$^\circ\text{C}/\text{W}$

Notes:

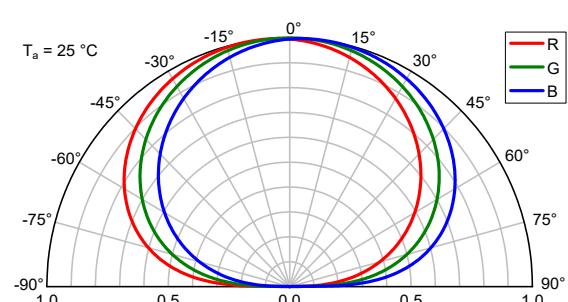
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. $R_{\text{th JA}}, R_{\text{th JS}}$ Results from mounting on PC board FR4 (pad size $\geq 16\text{ mm}^2$ per pad).
3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

TECHNICAL DATA

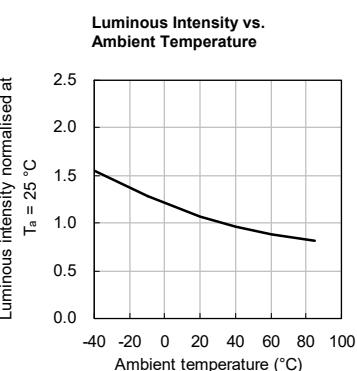
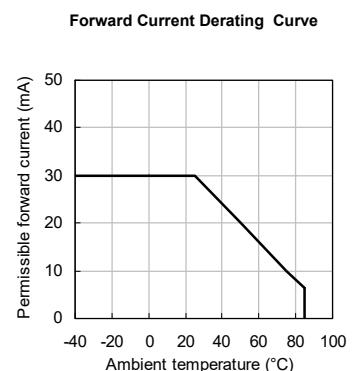
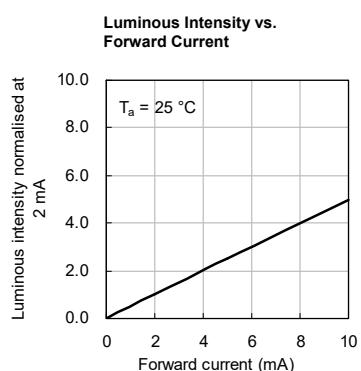
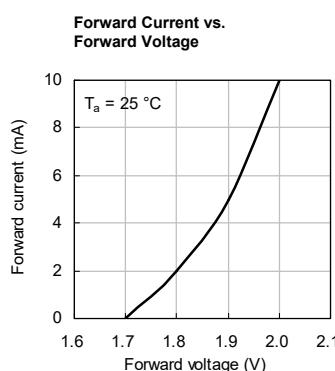
RELATIVE INTENSITY vs. WAVELENGTH



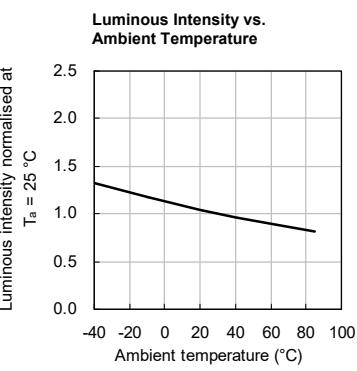
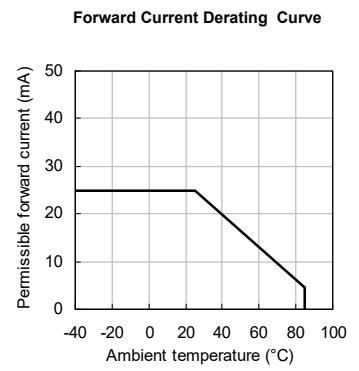
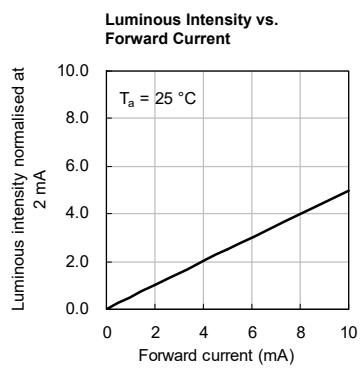
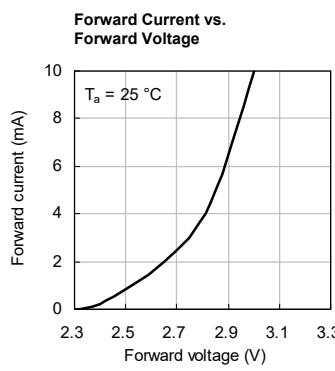
SPATIAL DISTRIBUTION



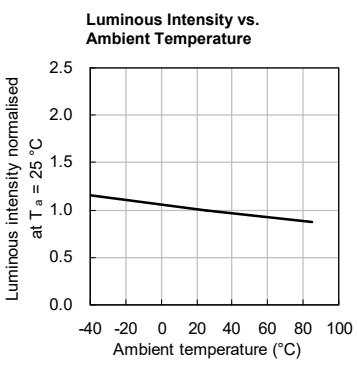
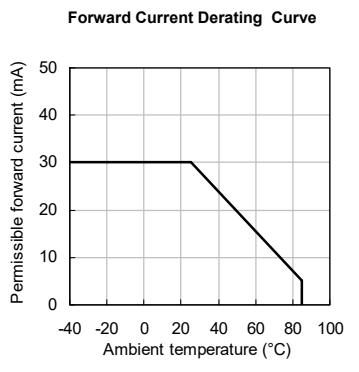
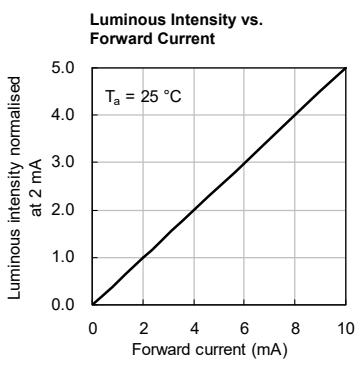
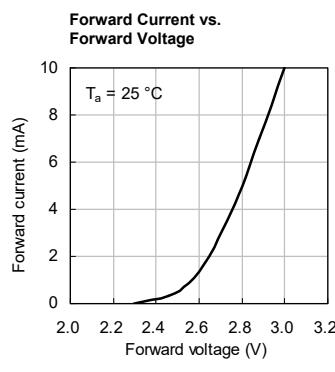
HYPER RED



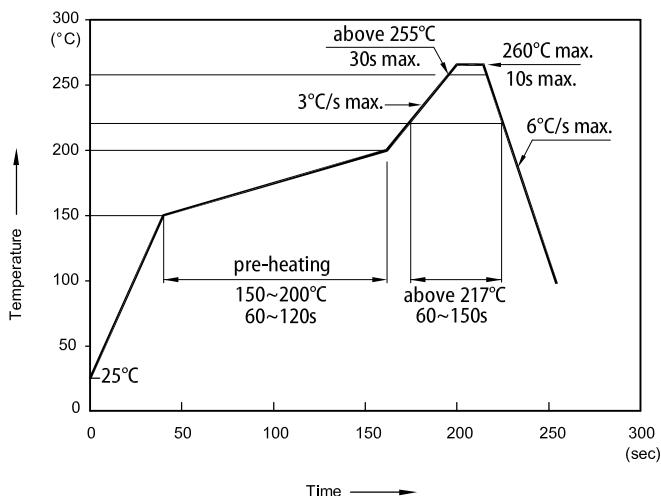
GREEN



BLUE

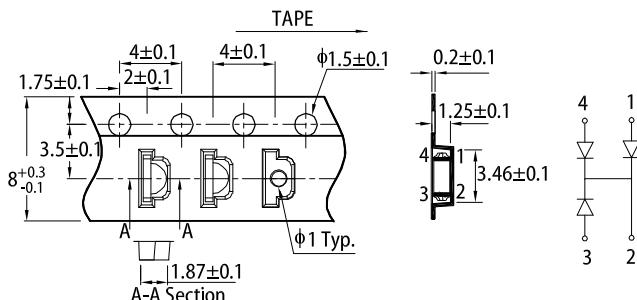


REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

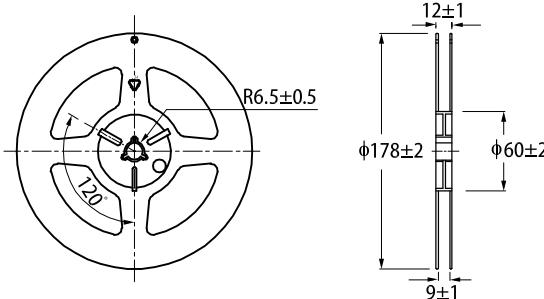


Notes:

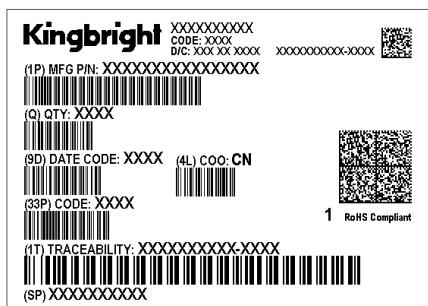
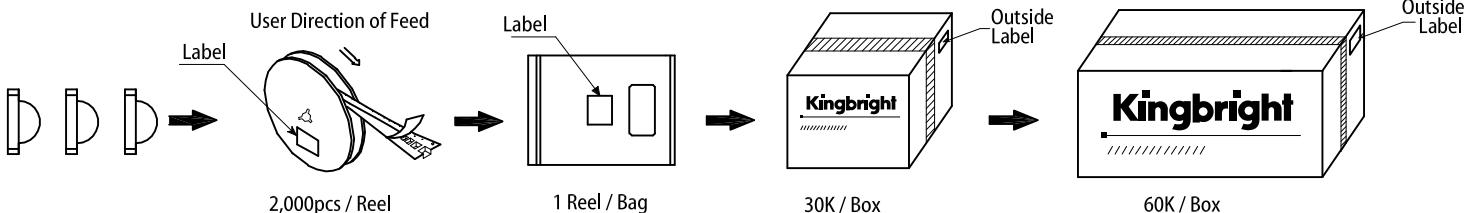
TAPE SPECIFICATIONS (units : mm)



REEL DIMENSION (units : mm)



PACKING & LABEL SPECIFICATIONS



PRECAUTIONARY NOTES

1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
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